NCE N-Channel Enhancement Mode Power MOSFET

Description

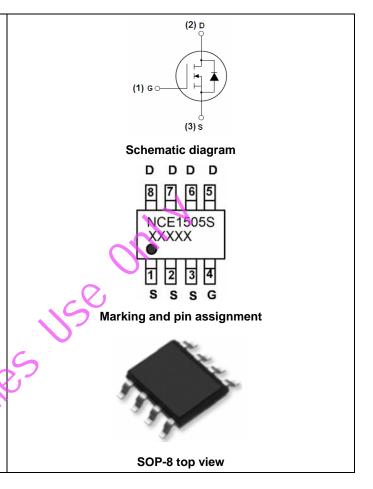
The NCE1505S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =150V, I_{D} =5.2A $R_{DS(ON)}$ < 44mΩ @ V_{GS} =10V (Typ: 31mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE1505S	NCE1505S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	5.2	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	3.7	Α
Pulsed Drain Current(Note 1)	I _{DM}	42	Α
Maximum Power Dissipation	P _D	3.5	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient Note 2)	$R_{\theta JA}$	35.7	°C/W
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NCE1505S

Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	150	170	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	3.2	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =5.2A	-	31	44	mΩ
Forward Transconductance	g FS	V _{DS} =50V,I _D =5.2A	12	-	-	S
Dynamic Characteristics (Note4)	•	•	1			
Input Capacitance	C _{lss}	V -25V/V -0V	-	1700	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	190	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UMHZ	-	90	-	PF
Switching Characteristics (Note 4)		160	•			
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	t _r	V_{DD} =75V, I_{D} =3.1A V_{GS} =10V, R_{GEN} =6.5 Ω	-	13	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10V,R _{GEN} =6.5 Ω	-	26	-	nS
Turn-Off Fall Time	t _f		-	14	-	nS
Total Gate Charge	Q_g	V _{DS} =75V,I _D =3.1A,	-	35.8	-	nC
Gate-Source Charge	Q_{gs}	$V_{DS}=75V,I_{D}=3.1A,$ $V_{GS}=10V$	-	7.5	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V	-	13	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0 V , I_{S} =3.1 A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	2.7	Α
Reverse Recovery Time	trr	$T_J = 25^{\circ}C$, $I_F = 3.1A$,	-	50	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	140	-	nC
Fox						

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production.

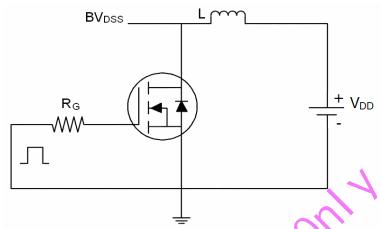
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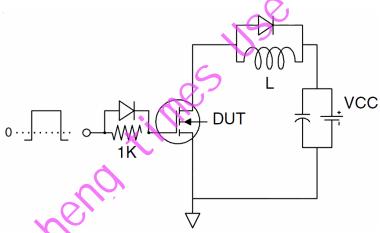
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Test Circuit

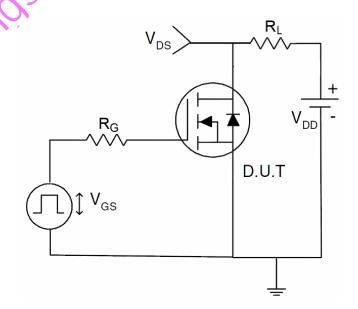
1) E_{AS} test Circuits



2) Gate charge test Circuit

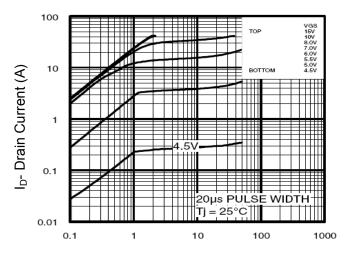


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

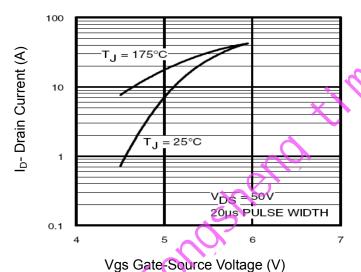


Figure 2 Transfer Characteristics

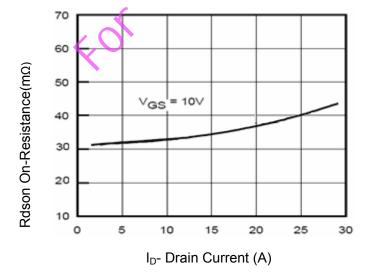


Figure 3 Rdson- Drain Current

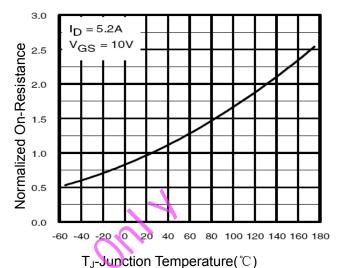


Figure 4 Rdson-JunctionTemperature

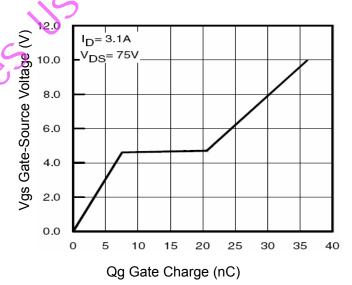


Figure 5 Gate Charge

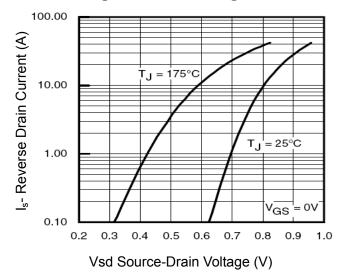
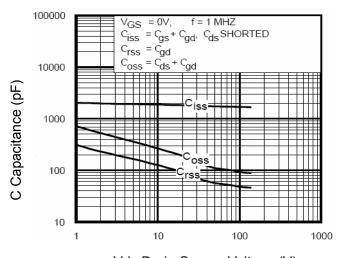


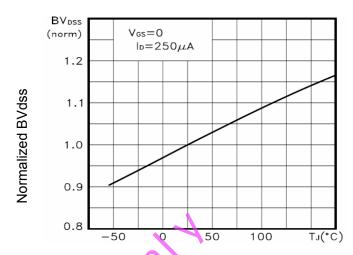
Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



T_J-Junction Temperature(℃)

Figure 9 BV_{DSS} vs Junction Temperature

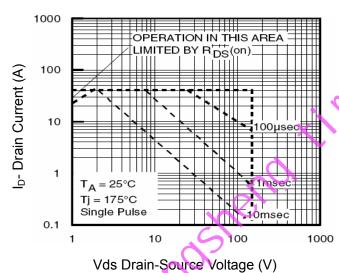
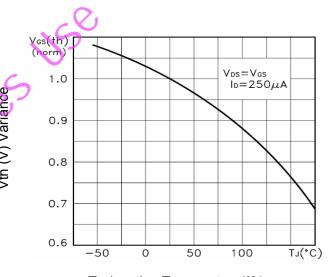


Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 10 V_{GS(th)} vs Junction Temperatur

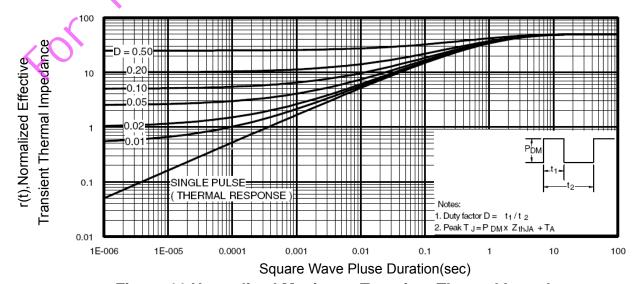


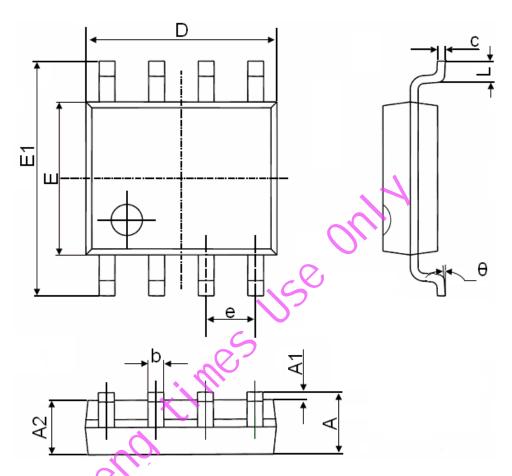
Figure 11 Normalized Maximum Transient Thermal Impedance

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SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	1,350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	D(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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